

A

B

C

D

E

F

A

B

C

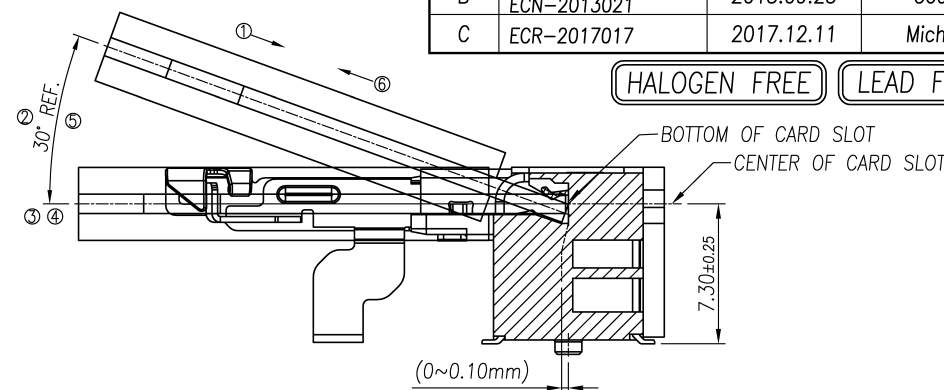
D

E

F

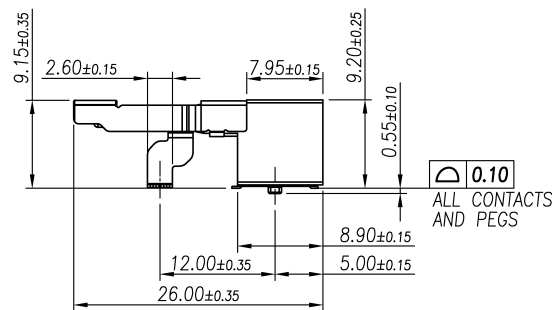
REV.	MODIFICATION	DATE	DRAW
A	INITIAL RELEASE	2013.05.15	Coco
B	ECN-2013014 ECN-2013021	2013.09.25	Coco
C	ECR-2017017	2017.12.11	Michael

HALOGEN FREE LEAD FREE



MATING: ① INSERTING(30°) → ② ROTATING → ③ FIXED
UNMATING: ④ UNFIXED → ⑤ ROTATING → ⑥ WITHDRAWING

MATING/UNMATING VIEW
SCALE 2:1

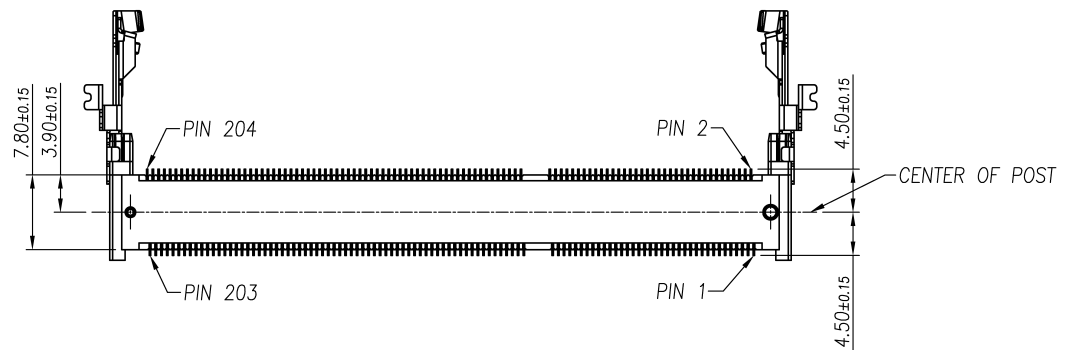
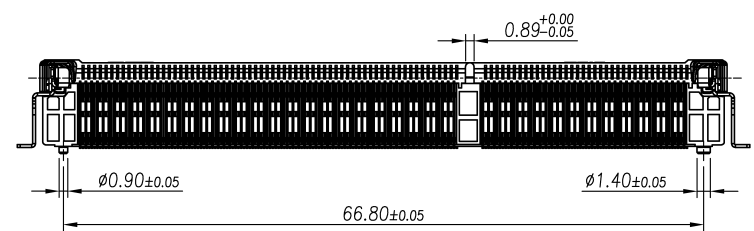
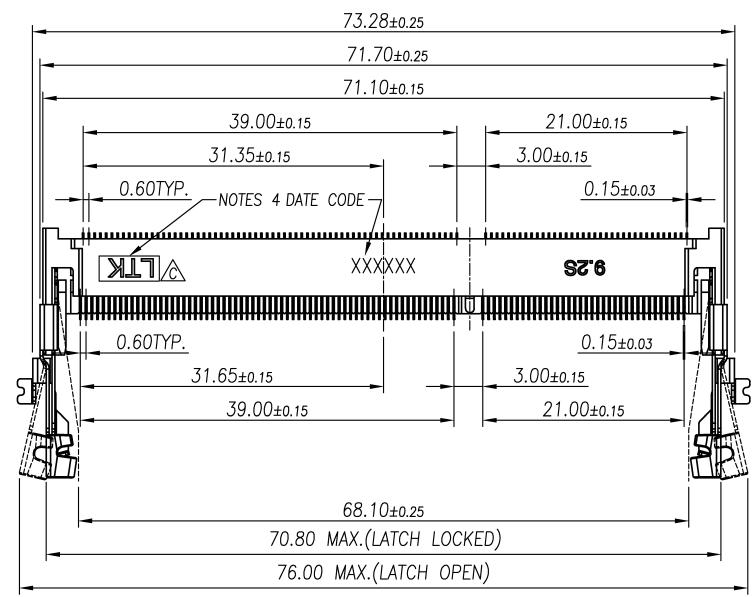


NOTES
1.MATERIAL
HOUSING: THERMOPLASTIC UL94V-0 COLOR BLACK
CONTACT: COPPER ALLOY, T=0.15mm.
LATCH: SUS, T=0.30mm.
PEG: SUS, T=0.30mm.
2.FINISH
CONTACT: GOLD PLATING ON CONTACT AREA AND
1u"~3u"GOLD PLATING ON SOLDER AREA
50u"~150u" NICKEL UNDER PLATING OVER ALL
PEG: 80u"~150u" MATTE TIN PLATING OVER ALL
50u"~150u" NICKEL UNDER PLATING OVER ALL
3.MSL LEVEL:
MSL(MOISTURE SENSITIVITY LEVEL)=1.
4.PART NO. : DS1SK-204XX-XX9DX
PLATING CONTACT
01 : GOLD FLASH
10 : GOLD 10u"Min.
No:Have LTK Logo
+:No LTK Logo
PACKING
TP: TAPE REEL

DATE CODE :

XX XX X X
TEAM
DAY
WEEK
YEAR

LINKTEK



DIMENSION IN mm [Inch]		PROD. SPEC. SP-DSXXXL1	ARGOSY RESEARCH INC.		
TOLERANCE UNLESS OTHERWISE SPECIFIED		PKG. SPEC. PK-DSXXX-001			
.X±0.35	X.*± 1*	APR. Kevin 2017.12.11	TITLE: DDR III 9.2H STD CONNECTOR		
.XX±0.25	.X.*±	CHK. Andy 2017.12.11	FILE NO. ARG-116	DWG NO. DS1SK-204XX-XX9DX	
.XXX±	.XX.*±	DRA. Michael 2017.12.11	PROJ.	CUSTOMER DRAWING	
			SIZE A4	SCALE 1:1	SHEET 1/3
				REV. C	C

